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Bib Data Sheet

SERIAL NUMBER 10/698,432	FILING DATE 11/03/2003 RULE	CLASS 257 438	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. 108086.01
APPLICANTS Terunao Hanaoka, Suwa-shi, JAPAN; Kenji Wada, Suwa-gun, JAPAN; Nobuaki Hashimoto, Suwa-shi, JAPAN; Haruki Ito, Chino-shi, JAPAN; Kazushige Umetsu, Chino-shi, JAPAN; Fumiaki Matsushima, Chino-shi, JAPAN;				
** CONTINUING DATA ***** yes K.N. This application is a CON of 09/765,433 01/22/2001 PAT 6,667,551				
** FOREIGN APPLICATIONS ***** yes K.N. JAPAN 2000-012670 01/21/2000				
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 02/02/2004				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and <u>K. N.</u> K.N. Acknowledged Examiner's Signature Initials	STATE OR COUNTRY JAPAN	SHEETS DRAWING 11	TOTAL CLAIMS 1	INDEPENDENT CLAIMS 1
ADDRESS 25944 OLIFF & BERRIDGE, PLC P.O. BOX 19928 ALEXANDRIA, VA 22320				
TITLE Semiconductor device and manufacturing method therefor, circuit board, and electronic equipment				
FILING FEE	FEES: Authority has been given in Paper			
<div style="float: right;"> <input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of </div>				